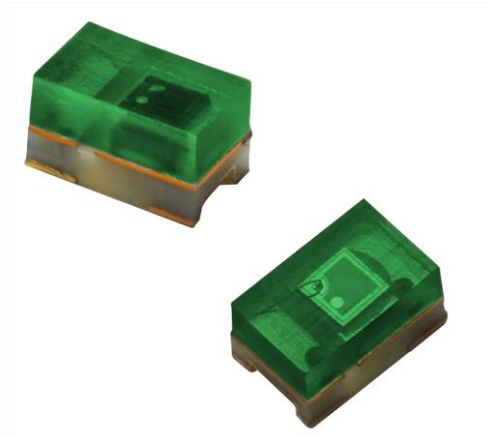
Ambient Light Sensor in 0805 Package



FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Supression filter for near infrared radiation
- Angle of half sensitivity: φ = ± 60°
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE
Pb-free
e4
RoHS COMPLIANT
HALOGEN FREE
GREEN (5-2008)

DESCRIPTION

TEMT6200FX01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 0805 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 550 nm.

APPLICATIONS

- Automotive sensors
- Ambient light sensor for display backlight dimming in:
  - Mobile phones
  - Notebook computers
  - PDAs
  - Cameras
  - Dashboards

PRODUCT SUMMARY

COMPONENT	I_{PCE} (μA)	φ (deg)	$\lambda_{0.5}$ (nm)
TEMT6200FX01	23	± 60	450 to 610

Note

- Test condition see table “Basic Characteristics”

ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT6200FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel. Label with I_{PCE} group on each reel. Specifications of group A/B/C see table “Type Dedicated Characteristics”	0805

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		V_{CEO}	6	V
Emitter collector voltage		V_{ECO}	1.5	V
Collector current		I_C	20	mA
Power dissipation		P_V	100	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	-40 to +100	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	Acc. reflow profile fig. 9	T_{sd}	260	°C
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	R_{thJA}	450	K/W

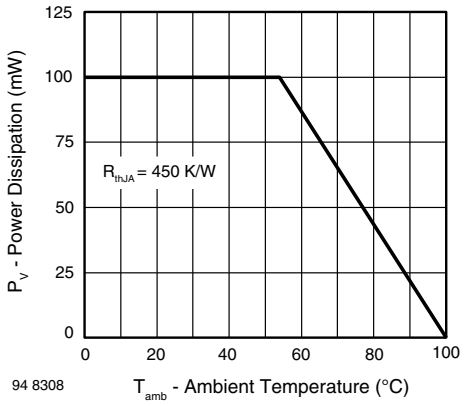


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Collector emitter breakdown voltage	I_C = 0.1 mA	V_{CEO}	6			V
Collector dark current	V_{CE} = 5 V, E = 0 lx	I_{CEO}		3	50	nA
Collector emitter capacitance	V_{CE} = 0 V, f = 1 MHz, E = 0 lx	C_{CEO}		16		pF
Photo current	E_V = 20 lx, CIE illuminant A, V_{CE} = 5 V	I_{PCE}		4.6		µA
	E_V = 100 lx, CIE illuminant A, V_{CE} = 5 V	I_{PCE}	7.5	23	39	µA
Temperature coefficient of I_{PCE}	CIE illuminant A	TK_{IPCE}		1.18		%/K
	LED, white	TK_{IPCE}		0.9		%/K
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λ_p		550		nm
Range of spectral bandwidth		$\lambda_{0.5}$		450 to 610		nm
Collector emitter saturation voltage	E_V = 20 lx, 0.45 µA	V_{CEsat}		0.1		V

TYPE DEDICATED CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**BINNED GROUP**	**SYMBOL**	**MIN.**	**MAX.**	**UNIT**
Photo current	E_V = 100 lx, CIE illuminant A, V_{CE}tz51 = 5 V	A	I_{PCE}	7.5	15	µA
		B	I_{PCE}	12	24	µA
		C	I_{PCE}	19.5	39	µA

Note

- Each 3000 piece packing unit will contain a single group. The label on the bag will indicate which binned group is in the bag. A specific group cannot be ordered. Production shipments containing multiple bags will likely include multiple groups. Please design accordingly.

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

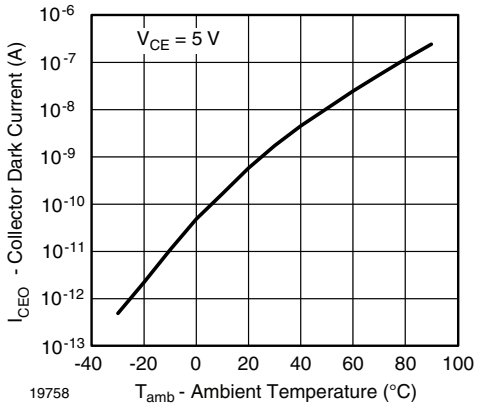


Fig. 2 - Collector Dark Current vs. Ambient Temperature

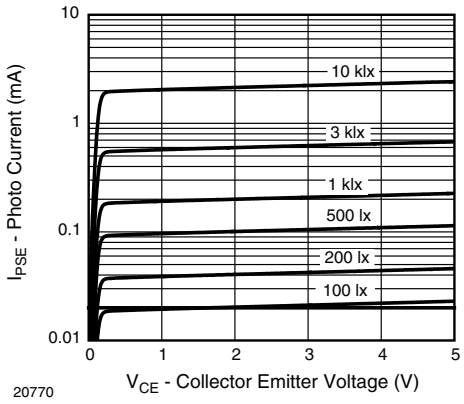


Fig. 5 - Photo Current vs. Collector Emitter Voltage

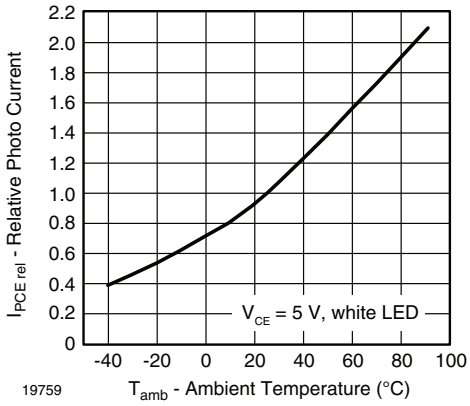


Fig. 3 - Relative Photo Current vs. Ambient Temperature

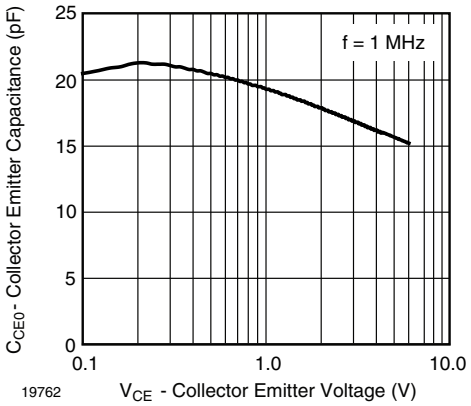


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

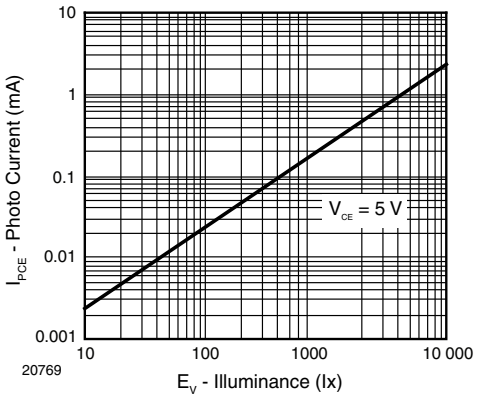


Fig. 4 - Photo Current vs. Illuminance

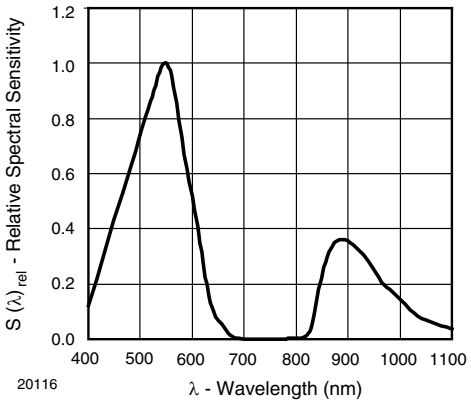


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

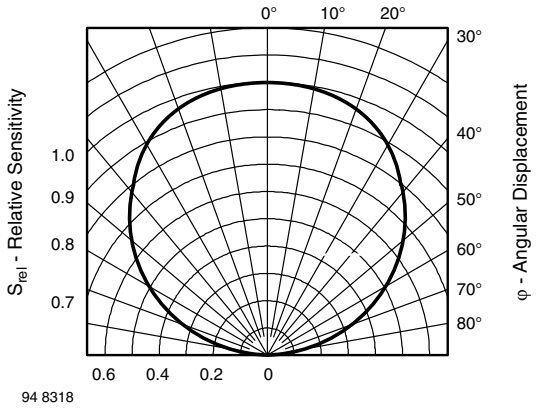


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE

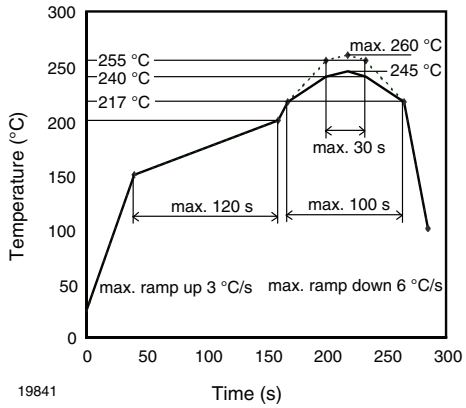


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

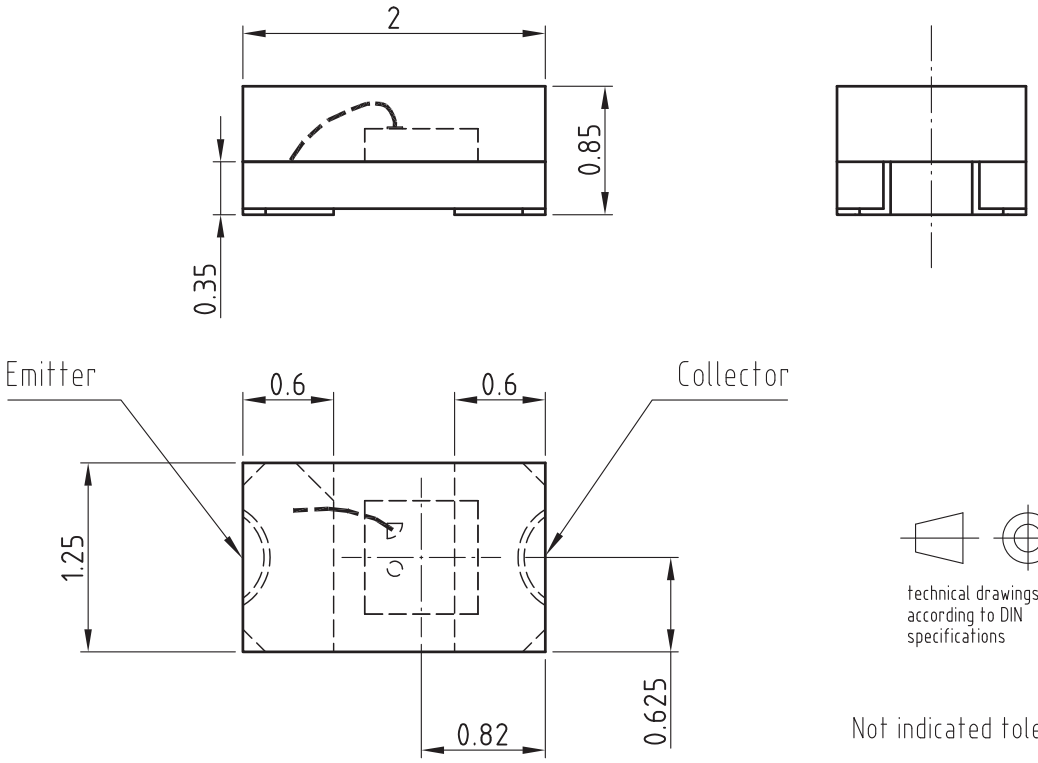
Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

DRYING

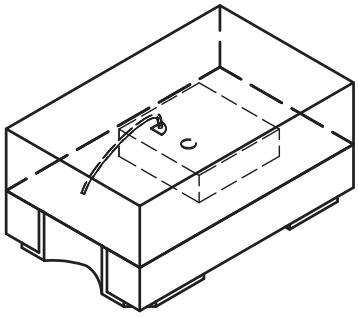
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENSIONS in millimeters

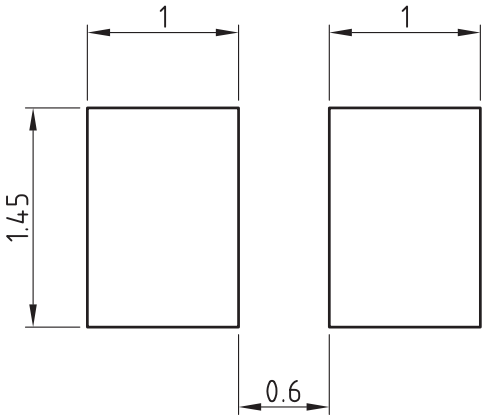


technical drawings
according to DIN
specifications

Not indicated tolerances ±0.1



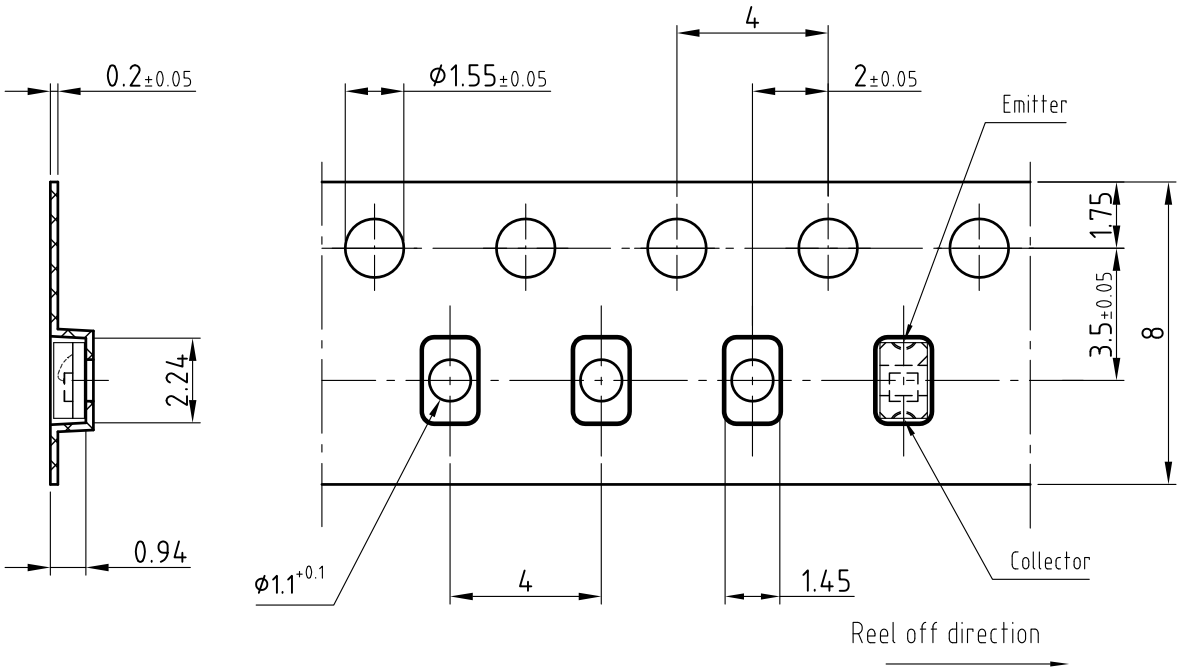
Recommended solder pad
Footprint



Drawing-No.: 6.541-5063.01-4
Issue: 3; 23.02.07

19757

BLISTER TAPE DIMENSIONS in millimeters



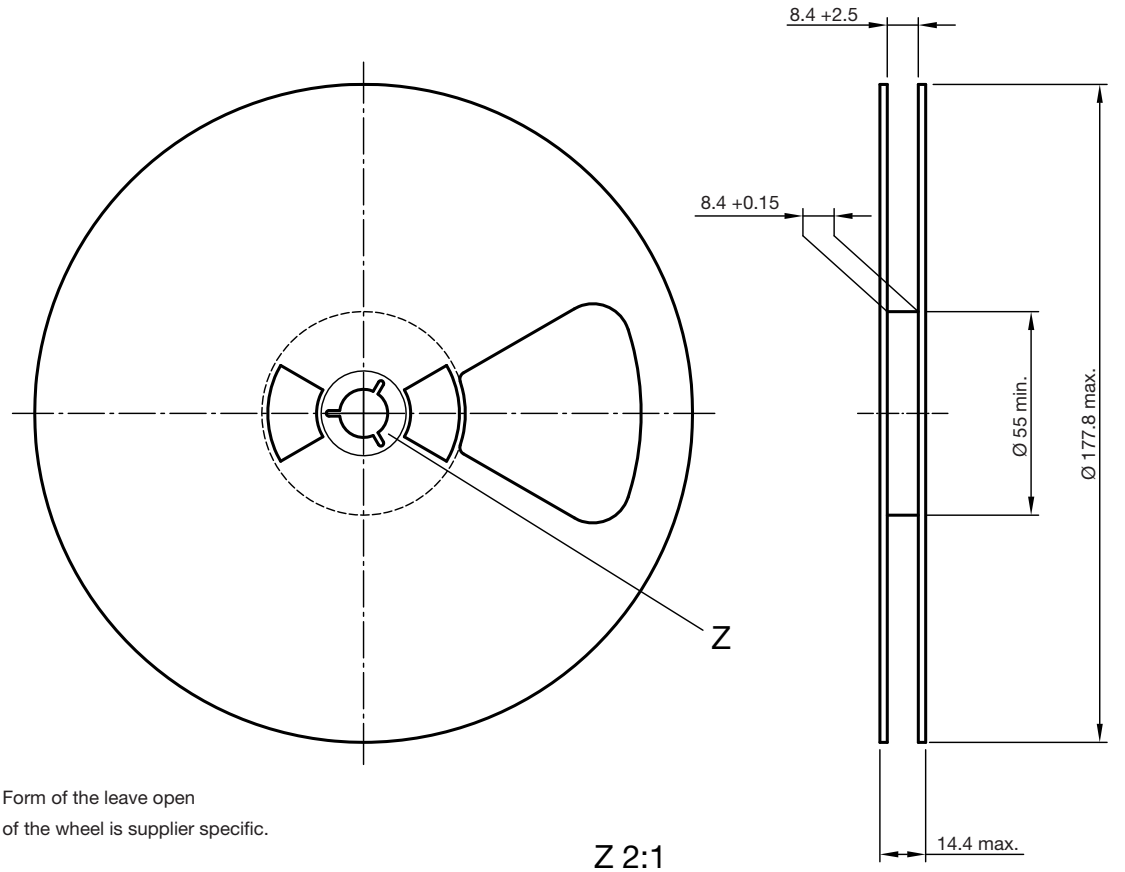
Drawing-No.: 9.700-5310.01-4
Issue: 2; 14.08.07
20690

Not indicated tolerances ±0.1

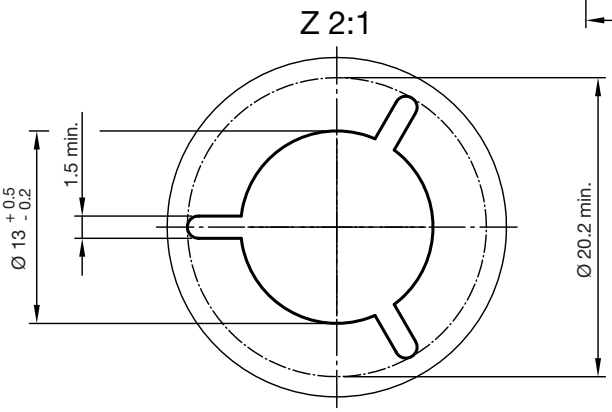
Quantity per reel: 3000 pcs

technical drawings
according to DIN
specifications

REEL DIMENSIONS in millimeters



Form of the leave open
of the wheel is supplier specific.



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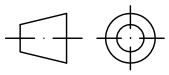

technical drawings
according to DIN
specifications

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